

Josep Forges Nogués, founder of TEF, asserted that the most valuable asset of any organization is its people. With this conviction, he established TEF Montajes y Servicios in 1982, over 40 years ago.

Our purpose is to provide subcontracting services in electronic assembly to manufacturers in need, through continuous improvement in quality, exceptional service, and a commitment to the development of our human team.

These principles have been pivotal in TEF's evolution to date. Currently, under the leadership of the second generation of the family, we maintain the same spirit and continue to trust in the vision laid out by our founder.



Josep Forges Nogués founds TEF Montajes as an electronics workshop in Hospitalet de Llobregat.

1982

Relocation to the historic building "La Vanguard" in Hospitalet de Llobregat, and SMT assembly begins.

1985

Relocation to the Fonollard Nord Industrial Park (current of SMT lines and the need for more space.

2008

Expansion of facilities in Sant Boi de Llobregat (3,800 m<sup>2</sup>) and increase to

2017



**Automotive** 



Lighting



**Electromechanics** 



Medical devices





#### **THE TEF FAMILY**

At TEF, we manufacture electronic boards tailored to the needs of our clients using the most advanced technology available. However, undoubtedly, one of the keys to our success is our human team comprised of technicians, engineers, inventors, specialists, managers, salespeople, administrative staff, and more. The TEF family is vast and diverse, made up of highly qualified professionals in each of their respective fields.

We are a young, dynamic, and innovative team with a clearly technological profile and, most importantly, with ideas and a strong desire to continue growing, both professionally and personally.





Electronic equipment design department



**Test equipment** design department



**Technical** office



**Industrialization** department



**Technical** department



**Manufacturing** 



Quality department



**Purchasing** department



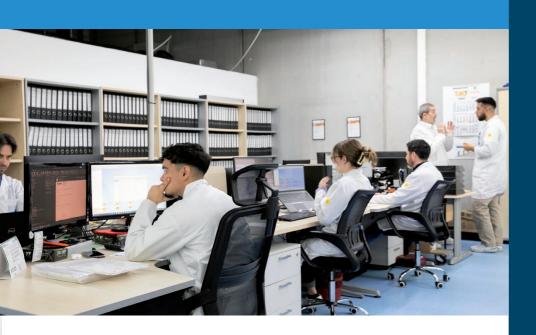
Logistics

Machinery renovation and structural improvements are carried out to continue our policy provide the best service to our customers.

2022

Expansion to 5 SMD lines and improvement of the factory layout, including enhancements in THT soldering with new machinery acquisitions.

2024



Yersatility, adaptability and flexibility are in our DNA.

## Assembly of electronic boards SMT (Surface Mount Technology)

At TEF, we have **5 fully equipped surface-mount technology (SMT)** component assembly lines, providing us with a nominal capacity of around 140,000 components per hour. These differentiated lines offer us great versatility in manufacturing and allow us to produce any type of series, whether they are small or large volume.

### **EQUIPMENT** Line

1 2 3

- ✓ Screen printing: MSTECH AT
- ✓ SPI: PEMTON
- ✓ Pick and place: HANWHA TECHWIN SM471 | HANWHA TECHWIN SM482 PLU
- ✓ Oven reflow: SHENZHEN KAIT HIGH-TECH CO LTD KTR-10
- ✓ Acumulator Rack (Fifo/Lifo)
- ✓ AOI: PEMTRON 3D AUTO OPTICAL INSPECTION EAGLE
  3D-8800HSL



### **EQUIPMENT Line**

4 5

- ✓ Screen printing: MSTECH AT
- ✓ SPI: 3D SOLDER PASTE INSPECTION SYSTEM MODELO
  TROI-7700EL
- ✓ Pick and place: HANWHA TECHWIN SM471 | HANWHA
  TECHWIN SM482 PLU
- ✓ Oven reflow: SHENZHEN KAIT HIGH-TECH CO LTD KTR-10
- ✓ Acumulator Rack (Fifo/Lifo)
- ✓ AOI: PEMTRON 3D AUTO OPTICAL INSPECTION EAGLE
  3D-8800HSL





Boosting production with cutting-edge technology.

# Assembly of electronic boards THT (Through Hole Technology)



This type of assembly, known as THT or conventional assembly, is carried out manually, allowing us to assemble a wide variety of components in any quantity. Once the components are placed on the board, we can proceed with soldering using different systems.

In our production lines, we use state-of-the-art soldering machines, including the Ersa Powerflow N2 and the Ersa Versaflow 40/50, as well as manual methods. At TEF, and true to our principles of innovation and sustainability, we have taken steps to **reduce our environmental footprint**.

We have invested in **soldering equipment** that uses nitrogen instead of more polluting technologies, thus eliminating obsolete machinery that caused greater environmental impact.





Los PCBs son productos complejos que requieren conocimiento, esfuerzo y tiempo para ser fiables. Porque se utilizan en productos de los que todos dependemos en nuestra vida cotidiana y esperamos que funcionen. ¿Cómo se convierten en fiables? ¿Qué determina su fiabilidad? ¿Es el espesor del cobre o la clase IPC la que decide?

Cada día tenemos preguntas como estas. Y nos encanta. Tenemos más de 490 expertos en PCB en tres continentes que hablan 19 idiomas y están a tu servicio. Independientemente de dónde estés o cúando tengas una pregunta, ¡contacta con nosotros!

¿Cuál es tu pregunta sobre PCB?

www.ncabgroup.com/es/preguntas-frecuentes-sobre-pcb/

Respuestas fiables. PCB fiables.



## **Finishes**

At TEF, we are committed to the continuous improvement of the finishes of the electronic boards we assemble. We offer three types of finishes depending on the intended use of the electronic board and its technical specifications or customer requirements.

Varnishing

With one of the most modern lines on the market (comprised of a NORDSON ASYMTEK SL-940 and a UVLED-FLIPPER-CCAOI curing oven) selectively varnishing the previously defined circuits and their drying.

2 Silicone

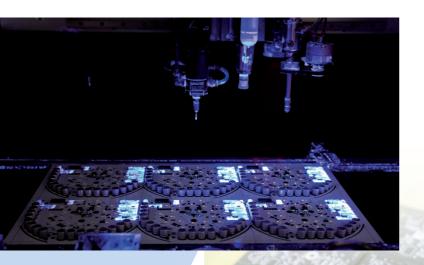
Silicone insulation ensures greater protection of the boards against impacts, temperature changes, humidity, dirt, and degradation caused by various factors.

3 Resins

Ideal for boards where electronic components need to be sealed to ensure total waterproofing, or that operate under extreme conditions.

O We offer a full range of electronic finishes to ensure maximum protection and performance of each assembled board.





## Mechanical assembly of electronic equipment



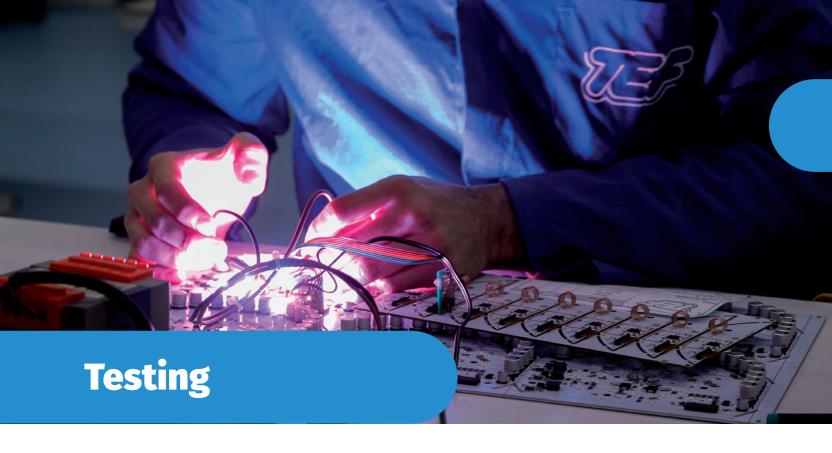
The mechanical assembly of electronic boards is a fundamental part of the services offered by TEF Montajes. At TEF, we carry out the integration of mechanical elements, such as casings, supports, heat sinks, and cooling systems, according to the product design requirements. Additionally, we offer the option of conducting performance tests to ensure the quality and durability of the final product delivered to our client.





Excellence in mechanical integration is essential. We finetune every detail to achieve total customer satisfaction.





All our products undergo rigorous inspections before leaving our facilities, thus guaranteeing their **quality and optimal performance**. To achieve this, we carry out exhaustive testing of the manufactured boards and equipment, using techniques such as functional testing, electrical tests, and flying probe testing (in-circuit).

Our success is based on the combination of cuttingedge technology and a human team composed of highly qualified technicians specialized in the sector. The deep knowledge of the electronic field and the extensive experience of the TEF team constitute our added value. Once the boards or equipment are delivered to their final destination, we also provide comprehensive aftersales service. We accompany our clients from the beginning of the project to the end of the product's life cycle, ensuring their continuous satisfaction.

At TEF, we offer our clients the opportunity to collaborate in the joint design of all the utensils necessary to provide these services. In addition, we make our knowledge and resources available to ensure the best outcome for both parties.

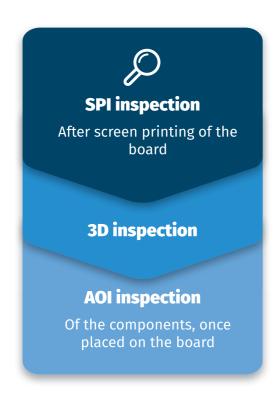


## **Inspection**

Boards incorporating BGA technology, once soldered, must undergo an X-ray inspection (RX). At TEF, we have a recently acquired state-of-the-art Nordson machine, with which we carry out a three-dimensional inspection of the parts.

With this installation, we process all the internal production of the plates and we offer an external verification service, which includes sending all the photographs taken to the client so that they can see the layout of the welds, voids, etc.

We also perform visual inspections in the previous steps of the process:



To carry out this inspection, we have a Pemtron 8800 HSL in 3D.



#### **BGA SOLDERING**

We have a rework machine, the Ersa PL 550A model, which allows us to repair faulty inserts and solder joints in BGA components. With this equipment, our technicians perform the entire rework process, which consists of several stages:

- > Desoldering the defective component.
- > Reballing.
- > Placement and soldering of the new component on the board.

Cutting-edge X-ray technology for BGA technology.





From the moment we start working on a project until it is fully operational, we take care of everything related to logistics. Our customised ERP (Enterprise Resource Planning) system enables us to oversee al phases of the process:



The selection of suppliers and the purchase of components and materials necessary for the manufacturing of each product.

The management of the stock of each customer.

The delivery of the producto both locally, nationally or internationally, by means of our own transport or companies specialised in the logistics sector.

Another important point is TEF's smart warehouses, which allow the traceability of the entire process to be fully automated. We currently have three warehouses focused on the storage of SMD and THT material.

These warehouses facilitate:

- > Precise stock control.
- > A drastic reduction of errors.
- Considerable savings in both manufacturing time and costs.

Logisticefficiency fromstart to finish.





## **Quality**



We have high quality standards thanks to our strict production registration processes and our concern for the environment



#### > ISO 9001:2015 Certificate

TEF has had this accreditation since 2002, which reflects our quality policy regarding our products and customer satisfaction.



#### > ISO 14001:2015 Certificate

Since 2011, we have had this accreditation which guarantees that our processes are sustainable and contribute to reducing the environmental impact of our activities.

#### Coming soon in 2024







